



Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	1920
Number of Logic Elements/Cells	17280
Total RAM Bits	442368
Number of I/O	173
Number of Gates	1000000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-LBGA
Supplier Device Package	256-FTBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s1000-4ft256i

DLL Clock Input Connections

An external clock source enters the FPGA using a Global Clock Input Buffer (IBUFG), which directly accesses the global clock network or an Input Buffer (IBUF). Clock signals within the FPGA drive a global clock net using a Global Clock Multiplexer Buffer (BUFGMUX). The global clock net connects directly to the CLKIN input. The internal and external connections are shown in the [a] and [c] sections, respectively, of [Figure 21](#). A differential clock (e.g., LVDS) can serve as an input to CLKIN.

DLL Clock Output and Feedback Connections

As many as four of the nine DCM clock outputs can simultaneously drive the four BUFGMUX buffers on the same die edge (top or bottom). All DCM clock outputs can simultaneously drive general routing resources, including interconnect leading to OBUF buffers.

The feedback loop is essential for DLL operation and is established by driving the CLKFB input with either the CLK0 or the CLK2X signal so that any undesirable clock distribution delay is included in the loop. It is possible to use either of these two signals for synchronizing any of the seven DLL outputs: CLK0, CLK90, CLK180, CLK270, CLKDV, CLK2X, or CLK2X180. The value assigned to the CLK_FEEDBACK attribute must agree with the physical feedback connection: a value of 1X for the CLK0 case, 2X for the CLK2X case. If the DCM is used in an application that does not require the DLL—i.e., only the DFS is used—then there is no feedback loop so CLK_FEEDBACK is set to NONE.

CLK2X feedback is only supported on all mask revision 'E' and later devices (see [Mask and Fab Revisions, page 58](#)), on devices with the "GQ" fabrication code, and on all versions of the XC3S50 and XC3S1000.

There are two basic cases that determine how to connect the DLL clock outputs and feedback connections: on-chip synchronization and off-chip synchronization, which are illustrated in [Figure 21](#).

Coarse Phase Shift Outputs of the DLL Component

In addition to CLK0 for zero-phase alignment to the CLKIN signal, the DLL also provides the CLK90, CLK180 and CLK270 outputs for 90°, 180° and 270° phase-shifted signals, respectively. These signals are described in [Table 16, page 33](#). Their relative timing in the Low Frequency Mode is shown in [Figure 22, page 37](#). The CLK90, CLK180 and CLK270 outputs are not available when operating in the High Frequency mode. (See the description of the DLL_FREQUENCY_MODE attribute in [Table 17, page 33](#).) For control in finer increments than 90°, see [Phase Shifter \(PS\), page 39](#).

Basic Frequency Synthesis Outputs of the DLL Component

The DLL component provides basic options for frequency multiplication and division in addition to the more flexible synthesis capability of the DFS component, described in a later section. These operations result in output clock signals with frequencies that are either a fraction (for division) or a multiple (for multiplication) of the incoming clock frequency. The CLK2X output produces an in-phase signal that is twice the frequency of CLKIN. The CLK2X180 output also doubles the frequency, but is 180° out-of-phase with respect to CLKIN. The CLKDIV output generates a clock frequency that is a predetermined fraction of the CLKIN frequency. The CLKDV_DIVIDE attribute determines the factor used to divide the CLKIN frequency. The attribute can be set to various values as described in [Table 17](#). The basic frequency synthesis outputs are described in [Table 16](#). Their relative timing in the Low Frequency Mode is shown in [Figure 22](#).

The CLK2X and CLK2X180 outputs are not available when operating in the High Frequency mode. See the description of the DLL_FREQUENCY_MODE attribute in [Table 18](#).

Duty Cycle Correction of DLL Clock Outputs

The CLK2X⁽¹⁾, CLK2X180, and CLKDV⁽²⁾ output signals ordinarily exhibit a 50% duty cycle—even if the incoming CLKIN signal has a different duty cycle. A 50% duty cycle means that the High and Low times of each clock cycle are equal. The DUTY_CYCLE_CORRECTION attribute determines whether or not duty cycle correction is applied to the CLK0, CLK90, CLK180 and CLK270 outputs. If DUTY_CYCLE_CORRECTION is set to TRUE, then the duty cycle of these four outputs is corrected to 50%. If DUTY_CYCLE_CORRECTION is set to FALSE, then these outputs exhibit the same duty cycle as the CLKIN signal. [Figure 22](#) compares the characteristics of the DLL's output signals to those of the CLKIN signal.

1. The CLK2X output generates a 25% duty cycle clock at the same frequency as the CLKIN signal until the DLL has achieved lock.
 2. The duty cycle of the CLKDV outputs may differ somewhat from 50% (i.e., the signal will be High for less than 50% of the period) when the CLKDV_DIVIDE attribute is set to a non-integer value *and* the DLL is operating in the High Frequency mode.



Spartan-3 FPGA Family: DC and Switching Characteristics

DS099 (v3.0) October 29, 2012

Product Specification

DC Electrical Characteristics

In this section, specifications may be designated as Advance, Preliminary, or Production. These terms are defined as follows:

- **Advance:** Initial estimates are based on simulation, early characterization, and/or extrapolation from the characteristics of other families. Values are subject to change. Although speed grades with this designation are considered relatively stable and conservative, some under-reporting might still occur. Use as estimates, not for production.
- **Preliminary:** Based on complete early silicon characterization. Devices and speed grades with this designation are intended to give a better indication of the expected performance of production silicon. The probability of under-reported delays is greatly reduced compared to Advance data. Use as estimates, not for production.
- **Production:** These specifications are approved only after silicon has been characterized over numerous production lots. There is no under-reporting of delays, and customers receive formal notification of any subsequent changes. Parameter values are considered stable with no future changes expected.

Production-quality systems must only use FPGA designs compiled with a Production status speed file. FPGA designs using a less mature speed file designation should only be used during system prototyping or preproduction qualification. FPGA designs with speed files designated as Advance or Preliminary should not be used in a production-quality system.

Whenever a speed file designation changes, as a device matures toward Production status, rerun the [latest Xilinx ISE® software](#) on the FPGA design to ensure that the FPGA design incorporates the latest timing information and software updates.

All parameter limits are representative of worst-case supply voltage and junction temperature conditions. **The following applies unless otherwise noted: The parameter values published in this module apply to all Spartan®-3 devices. AC and DC characteristics are specified using the same numbers for both commercial and industrial grades.** All parameters representing voltages are measured with respect to GND.

Mask and Fab Revisions

Some specifications list different values for one or more mask or fab revisions, indicated by the device top marking (see [Package Marking, page 5](#)). The revision differences involve the power ramp rates, differential DC specifications, and DCM characteristics. The most recent revision (mask rev E and GQ fab/geometry code) is errata-free with improved specifications than earlier revisions.

Mask rev E with fab rev GQ has been shipping since 2005 (see [XCN05009](#)) and has been 100% of Xilinx Spartan-3 device shipments since 2006. SCD 0974 was provided to ensure the receipt of the rev E silicon, but it is no longer needed. Parts ordered under the SCD appended “0974” to the standard part number. For example, “XC3S50-4VQ100C” became “XC3S50-4VQ100C0974”.

Table 28: Absolute Maximum Ratings

Symbol	Description	Conditions		Min	Max	Units
V_{CCINT}	Internal supply voltage relative to GND			−0.5	1.32	V
V_{CCAUX}	Auxiliary supply voltage relative to GND			−0.5	3.00	V
V_{CCO}	Output driver supply voltage relative to GND			−0.5	3.75	V
V_{REF}	Input reference voltage relative to GND			−0.5	$V_{CCO} + 0.5$	V
V_{IN}	Voltage applied to all User I/O pins and Dual-Purpose pins relative to GND ^(2,4)	Driver in a high-impedance state	Commercial	−0.95	4.4	V
			Industrial	−0.85	4.3	
	Voltage applied to all Dedicated pins relative to GND ⁽³⁾		All temp. ranges	−0.5	$V_{CCAUX} + 0.5$	V

© Copyright 2003–2012 Xilinx, Inc. XILINX, the Xilinx logo, Virtex, Spartan, ISE, Artix, Kintex, Zynq, Vivado and other designated brands included herein are trademarks of Xilinx in the United States and other countries. PCI and PCI-X are trademarks of PCI-SIG and used under license. All other trademarks are the property of their respective owners.

Table 41: System-Synchronous Pin-to-Pin Setup and Hold Times for the IOB Input Path (Cont'd)

Symbol	Description	Conditions	Device	Speed Grade		Units
				-5	-4	
				Min	Min	
T _{PHFD}	When writing to IFF, the time from the active transition at the Global Clock pin to the point when data must be held at the Input pin. The DCM is not in use. The Input Delay is programmed.	LVCMOS25 ⁽³⁾ , IOBDELAY = IFD, without DCM	XC3S50	-0.98	-0.93	ns
			XC3S200	-0.40	-0.35	ns
			XC3S400	-0.27	-0.22	ns
			XC3S1000	-1.19	-1.14	ns
			XC3S1500	-1.43	-1.38	ns
			XC3S2000	-2.33	-2.28	ns
			XC3S4000	-2.47	-2.42	ns
			XC3S5000	-2.66	-2.61	ns

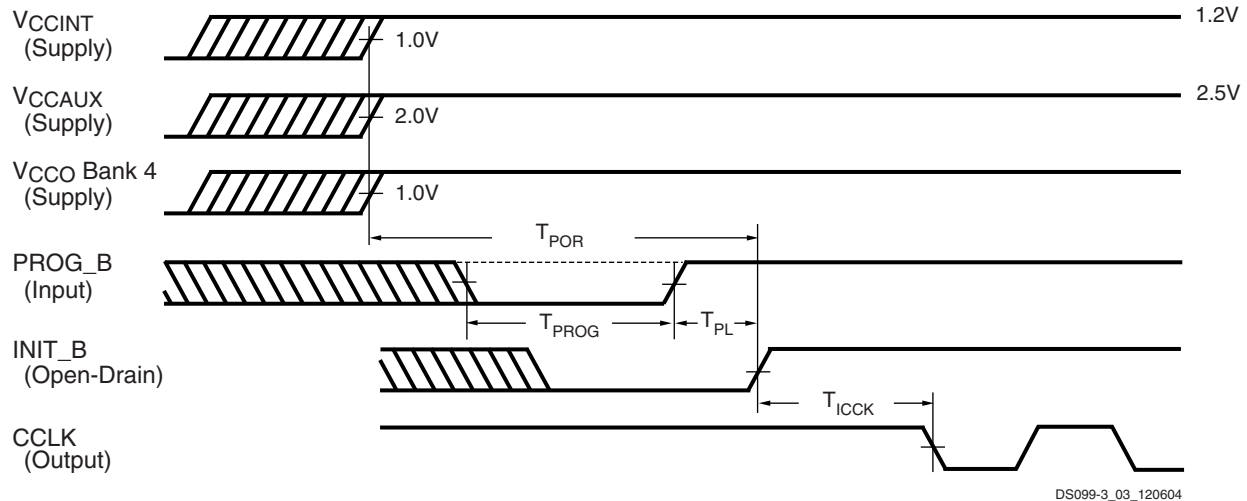
Notes:

1. The numbers in this table are tested using the methodology presented in [Table 48](#) and are based on the operating conditions set forth in [Table 32](#) and [Table 35](#).
2. This setup time requires adjustment whenever a signal standard other than LVCMOS25 is assigned to the Global Clock Input or the data Input. If this is true of the Global Clock Input, *subtract* the appropriate adjustment from [Table 44](#). If this is true of the data Input, *add* the appropriate Input adjustment from the same table.
3. This hold time requires adjustment whenever a signal standard other than LVCMOS25 is assigned to the Global Clock Input or the data Input. If this is true of the Global Clock Input, *add* the appropriate Input adjustment from [Table 44](#). If this is true of the data Input, *subtract* the appropriate Input adjustment from the same table. When the hold time is negative, it is possible to change the data before the clock's active edge.
4. DCM output jitter is included in all measurements.

Table 42: Setup and Hold Times for the IOB Input Path

Symbol	Description	Conditions	Device	Speed Grade		Units
				-5	-4	
				Min	Min	
Setup Times						
T _{IOPICK}	Time from the setup of data at the Input pin to the active transition at the ICLK input of the Input Flip-Flop (IFF). No Input Delay is programmed.	LVCMOS25 ⁽²⁾ , IOBDELAY = NONE	XC3S50	1.65	1.89	ns
			XC3S200	1.37	1.57	ns
			XC3S400	1.37	1.57	ns
			XC3S1000	1.65	1.89	ns
			XC3S1500	1.65	1.89	ns
			XC3S2000	1.65	1.89	ns
			XC3S4000	1.73	1.99	ns
			XC3S5000	1.82	2.09	ns
T _{IOPICKD}	Time from the setup of data at the Input pin to the active transition at the IFF's ICLK input. The Input Delay is programmed.	LVCMOS25 ⁽²⁾ , IOBDELAY = IFD	XC3S50	4.39	5.04	ns
			XC3S200	4.76	5.47	ns
			XC3S400	4.63	5.32	ns
			XC3S1000	5.02	5.76	ns
			XC3S1500	5.40	6.20	ns
			XC3S2000	6.68	7.68	ns
			XC3S4000	7.16	8.24	ns
			XC3S5000	7.33	8.42	ns

Configuration and JTAG Timing



Notes:

1. The V_{CCINT} , V_{CCAUX} , and V_{CCO} supplies may be applied in any order.
2. The Low-going pulse on PROG_B is optional after power-on but necessary for reconfiguration without a power cycle.
3. The rising edge of INIT_B samples the voltage levels applied to the mode pins (M0 - M2).

Figure 36: Waveforms for Power-On and the Beginning of Configuration

Table 65: Power-On Timing and the Beginning of Configuration

Symbol	Description	Device	All Speed Grades		Units
			Min	Max	
$T_{POR}^{(2)}$	The time from the application of V_{CCINT} , V_{CCAUX} , and V_{CCO} Bank 4 supply voltage ramps (whichever occurs last) to the rising transition of the INIT_B pin	XC3S50	—	5	ms
		XC3S200	—	5	ms
		XC3S400	—	5	ms
		XC3S1000	—	5	ms
		XC3S1500	—	7	ms
		XC3S2000	—	7	ms
		XC3S4000	—	7	ms
		XC3S5000	—	7	ms
T_{PROG}	The width of the low-going pulse on the PROG_B pin	All	0.3	—	μ s
$T_{PL}^{(2)}$	The time from the rising edge of the PROG_B pin to the rising transition on the INIT_B pin	XC3S50	—	2	ms
		XC3S200	—	2	ms
		XC3S400	—	2	ms
		XC3S1000	—	2	ms
		XC3S1500	—	3	ms
		XC3S2000	—	3	ms
		XC3S4000	—	3	ms
		XC3S5000	—	3	ms
T_{INIT}	Minimum Low pulse width on INIT_B output	All	250	—	ns
$T_{ICCK}^{(3)}$	The time from the rising edge of the INIT_B pin to the generation of the configuration clock signal at the CCLK output pin	All	0.25	4.0	μ s

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 32. This means power must be applied to all V_{CCINT} , V_{CCO} , and V_{CCAUX} lines.
2. Power-on reset and the clearing of configuration memory occurs during this period.
3. This specification applies only for the Master Serial and Master Parallel modes.

CCLK: Configuration Clock

The configuration clock signal on this pin synchronizes the reading or writing of configuration data. The CCLK pin is an input-only pin for the Slave Serial and Slave Parallel configuration modes. In the Master Serial and Master Parallel configuration modes, the FPGA drives the CCLK pin and CCLK should be treated as a full bidirectional I/O pin for signal integrity analysis.

Although the CCLK frequency is relatively low, Spartan-3 FPGA output edge rates are fast. Any potential signal integrity problems on the CCLK board trace can cause FPGA configuration to fail. Therefore, pay careful attention to the CCLK signal integrity on the printed circuit board. Signal integrity simulation with IBIS is recommended. For all configuration modes except JTAG, consider the signal integrity at every CCLK trace destination, including the FPGA's CCLK pin. For more details on CCLK design considerations, see Chapter 2 of [UG332, Spartan-3 Generation Configuration User Guide](#).

During configuration, the CCLK pin has a pull-up resistor to VCCAUX, regardless of the HSWAP_EN pin. After configuration, the CCLK pin is pulled High to VCCAUX by default as defined by the **CclkPin** bitstream selection, although this behavior is programmable. Any clocks applied to CCLK after configuration are ignored unless the bitstream option **Persist** is set to **Yes**, which retains the configuration interface. **Persist** is set to **No** by default. However, if **Persist** is set to **Yes**, then all clock edges are potentially active events, depending on the other configuration control signals.

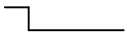
The bitstream generator option **ConfigRate** determines the frequency of the internally-generated CCLK oscillator required for the Master configuration modes. The actual frequency is approximate due to the characteristics of the silicon oscillator and varies by up to 50% over the temperature and voltage range. By default, CCLK operates at approximately 6 MHz. Via the **ConfigRate** option, the oscillator frequency is set at approximately 3, 6, 12, 25, or 50 MHz. At power-on, CCLK always starts operation at its lowest frequency. The device does not start operating at the higher frequency until the ConfigRate control bits are loaded during the configuration process.

PROG_B: Program/Configure Device

This asynchronous pin initiates the configuration or re-configuration processes. A Low-going pulse resets the configuration logic, initializing the configuration memory. This initialization process cannot finish until PROG_B returns High. Asserting PROG_B Low for an extended period delays the configuration process. At power-up, there is always a pull-up resistor to VCCAUX on this pin, regardless of the HSWAP_EN input. After configuration, the bitstream generator option **ProgPin** determines whether or not the pull-up resistor is present. By default, the **ProgPin** option retains the pull-up resistor.

After configuration, hold the PROG_B input High. Any Low-going pulse on PROG_B lasting 300 ns or longer restarts the configuration process.

Table 73: PROG_B Operation

PROG_B Input	Response
Power-up	Automatically initiates configuration process.
Low-going pulse 	Initiate (re-)configuration process and continue to completion.
Extended Low 	Initiate (re-)configuration process and stall process at step where configuration memory is cleared. Process is stalled until PROG_B returns High.
1	If the configuration process is started, continue to completion. If configuration process is complete, stay in User mode.

DONE: Configuration Done, Delay Start-Up Sequence

The FPGA produces a Low-to-High transition on this pin indicating that the configuration process is complete. The bitstream generator option **DriveDone** determines whether this pin functions as a totem-pole output that can drive High or as an open-drain output. If configured as an open-drain output—which is the default behavior—then a pull-up resistor is required to produce a High logic level. There is a bitstream option that provides an internal pull-up resistor, otherwise an external pull-up resistor is required.

The open-drain option permits the DONE lines of multiple FPGAs to be tied together, so that the common node transitions High only after all of the FPGAs have completed configuration. Externally holding the open-drain DONE pin Low delays the start-up sequence, which marks the transition to user mode.

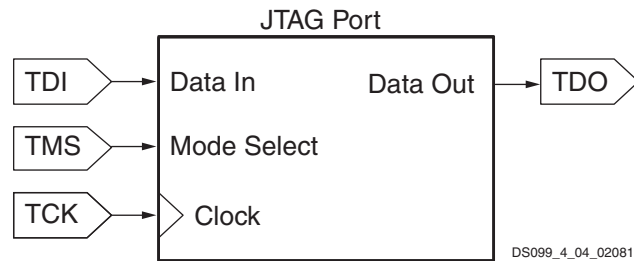


Figure 43: JTAG Port

IDCODE Register

Spartan-3 FPGAs contain a 32-bit identification register called the IDCODE register, as defined in the IEEE 1149.1 JTAG standard. The fixed value electrically identifies the manufacture (Xilinx) and the type of device being addressed over a JTAG chain. This register allows the JTAG host to identify the device being tested or programmed via JTAG. See [Table 78](#).

Using JTAG Port After Configuration

The JTAG port is always active and available before, during, and after FPGA configuration. Add the BSCAN_SPARTAN3 primitive to the design to create user-defined JTAG instructions and JTAG chains to communicate with internal logic.

Furthermore, the contents of the User ID register within the JTAG port can be specified as a Bitstream Generation option. By default, the 32-bit User ID register contains 0xFFFFFFFF.

Table 78: Spartan-3 JTAG IDCODE Register Values (hexadecimal)

Part Number	IDCODE Register
XC3S50	0x0140C093
XC3S200	0x01414093
XC3S400	0x0141C093
XC3S1000	0x01428093
XC3S1500	0x01434093
XC3S2000	0x01440093
XC3S4000	0x01448093
XC3S5000	0x01450093

Precautions When Using the JTAG Port in 3.3V Environments

The JTAG port is powered by the +2.5V VCCAUX power supply. When connecting to a 3.3V interface, the JTAG input pins must be current-limited using a series resistor. Similarly, the TDO pin is a CMOS output powered from +2.5V. The TDO output can directly drive a 3.3V input but with reduced noise immunity. See [3.3V-Tolerant Configuration Interface, page 47](#). See also [XAPP453: The 3.3V Configuration of Spartan-3 FPGAs](#) for additional details.

The following interface precautions are recommended when connecting the JTAG port to a 3.3V interface.

- Avoid actively driving the JTAG input signals High with 3.3V signal levels. If required in the application, use series current-limiting resistors to keep the current below 10 mA per pin.
- If possible, drive the FPGA JTAG inputs with drivers that can be placed in high-impedance (Hi-Z) after using the JTAG port. Alternatively, drive the FPGA JTAG inputs with open-drain outputs, which only drive Low. In both cases, pull-up resistors are required. The FPGA JTAG pins have pull-up resistors to VCCAUX before configuration and optional pull-up resistors after configuration, controlled by [Bitstream Options, page 125](#).

Table 91: TQ144 Package Pinout (Cont'd)

Bank	XC3S50, XC3S200, XC3S400 Pin Name	TQ144 Pin Number	Type
5	IO_L32P_5/GCLK2	P52	GCLK
6	IO_L01N_6/VRP_6	P36	DCI
6	IO_L01P_6/VRN_6	P35	DCI
6	IO_L20N_6	P33	I/O
6	IO_L20P_6	P32	I/O
6	IO_L21N_6	P31	I/O
6	IO_L21P_6	P30	I/O
6	IO_L22N_6	P28	I/O
6	IO_L22P_6	P27	I/O
6	IO_L23N_6	P26	I/O
6	IO_L23P_6	P25	I/O
6	IO_L24N_6/VREF_6	P24	VREF
6	IO_L24P_6	P23	I/O
6	IO_L40N_6	P21	I/O
6	IO_L40P_6/VREF_6	P20	VREF
7	IO/VREF_7	P4	VREF
7	IO_L01N_7/VRP_7	P2	DCI
7	IO_L01P_7/VRN_7	P1	DCI
7	IO_L20N_7	P6	I/O
7	IO_L20P_7	P5	I/O
7	IO_L21N_7	P8	I/O
7	IO_L21P_7	P7	I/O
7	IO_L22N_7	P11	I/O
7	IO_L22P_7	P10	I/O
7	IO_L23N_7	P13	I/O
7	IO_L23P_7	P12	I/O
7	IO_L24N_7	P15	I/O
7	IO_L24P_7	P14	I/O
7	IO_L40N_7/VREF_7	P18	VREF
7	IO_L40P_7	P17	I/O
0,1	VCCO_TOP	P126	VCCO
0,1	VCCO_TOP	P138	VCCO
0,1	VCCO_TOP	P115	VCCO
2,3	VCCO_RIGHT	P106	VCCO
2,3	VCCO_RIGHT	P75	VCCO
2,3	VCCO_RIGHT	P91	VCCO
4,5	VCCO_BOTTOM	P54	VCCO
4,5	VCCO_BOTTOM	P43	VCCO
4,5	VCCO_BOTTOM	P66	VCCO
6,7	VCCO_LEFT	P19	VCCO

Table 93: PQ208 Package Pinout (Cont'd)

Bank	XC3S50 Pin Name	XC3S200, XC3S400 Pin Names	PQ208 Pin Number	Type
3	IO_L20P_3	IO_L20P_3	P114	I/O
3	IO_L21N_3	IO_L21N_3	P117	I/O
3	IO_L21P_3	IO_L21P_3	P116	I/O
3	IO_L22N_3	IO_L22N_3	P120	I/O
3	IO_L22P_3	IO_L22P_3	P119	I/O
3	IO_L23N_3	IO_L23N_3	P123	I/O
3	IO_L23P_3/VREF_3	IO_L23P_3/VREF_3	P122	VREF
3	IO_L24N_3	IO_L24N_3	P125	I/O
3	IO_L24P_3	IO_L24P_3	P124	I/O
3	N.C. (◆)	IO_L39N_3	P128	I/O
3	N.C. (◆)	IO_L39P_3	P126	I/O
3	IO_L40N_3/VREF_3	IO_L40N_3/VREF_3	P131	VREF
3	IO_L40P_3	IO_L40P_3	P130	I/O
3	VCCO_3	VCCO_3	P110	VCCO
3	VCCO_3	VCCO_3	P127	VCCO
4	IO	IO	P93	I/O
4	N.C. (◆)	IO	P97	I/O
4	IO/VREF_4	IO/VREF_4	P85	VREF
4	N.C. (◆)	IO/VREF_4	P96	VREF
4	IO/VREF_4	IO/VREF_4	P102	VREF
4	IO_L01N_4/VRP_4	IO_L01N_4/VRP_4	P101	DCI
4	IO_L01P_4/VRN_4	IO_L01P_4/VRN_4	P100	DCI
4	IO_L25N_4	IO_L25N_4	P95	I/O
4	IO_L25P_4	IO_L25P_4	P94	I/O
4	IO_L27N_4/DIN/D0	IO_L27N_4/DIN/D0	P92	DUAL
4	IO_L27P_4/D1	IO_L27P_4/D1	P90	DUAL
4	IO_L30N_4/D2	IO_L30N_4/D2	P87	DUAL
4	IO_L30P_4/D3	IO_L30P_4/D3	P86	DUAL
4	IO_L31N_4/INIT_B	IO_L31N_4/INIT_B	P83	DUAL
4	IO_L31P_4/DOUT/BUSY	IO_L31P_4/DOUT/BUSY	P81	DUAL
4	IO_L32N_4/GCLK1	IO_L32N_4/GCLK1	P80	GCLK
4	IO_L32P_4/GCLK0	IO_L32P_4/GCLK0	P79	GCLK
4	VCCO_4	VCCO_4	P84	VCCO
4	VCCO_4	VCCO_4	P98	VCCO
5	IO	IO	P63	I/O
5	IO	IO	P71	I/O
5	IO/VREF_5	IO/VREF_5	P78	VREF
5	IO_L01N_5/RDWR_B	IO_L01N_5/RDWR_B	P58	DUAL
5	IO_L01P_5/CS_B	IO_L01P_5/CS_B	P57	DUAL
5	IO_L10N_5/VRP_5	IO_L10N_5/VRP_5	P62	DCI

Table 93: PQ208 Package Pinout (Cont'd)

Bank	XC3S50 Pin Name	XC3S200, XC3S400 Pin Names	PQ208 Pin Number	Type
5	IO_L10P_5/VRN_5	IO_L10P_5/VRN_5	P61	DCI
5	IO_L27N_5/VREF_5	IO_L27N_5/VREF_5	P65	VREF
5	IO_L27P_5	IO_L27P_5	P64	I/O
5	IO_L28N_5/D6	IO_L28N_5/D6	P68	DUAL
5	IO_L28P_5/D7	IO_L28P_5/D7	P67	DUAL
5	IO_L31N_5/D4	IO_L31N_5/D4	P74	DUAL
5	IO_L31P_5/D5	IO_L31P_5/D5	P72	DUAL
5	IO_L32N_5/GCLK3	IO_L32N_5/GCLK3	P77	GCLK
5	IO_L32P_5/GCLK2	IO_L32P_5/GCLK2	P76	GCLK
5	VCCO_5	VCCO_5	P60	VCCO
5	VCCO_5	VCCO_5	P73	VCCO
6	N.C. (◆)	IO/VREF_6	P50	VREF
6	IO_L01N_6/VRP_6	IO_L01N_6/VRP_6	P52	DCI
6	IO_L01P_6/VRN_6	IO_L01P_6/VRN_6	P51	DCI
6	IO_L19N_6	IO_L19N_6	P48	I/O
6	IO_L19P_6	IO_L19P_6	P46	I/O
6	IO_L20N_6	IO_L20N_6	P45	I/O
6	IO_L20P_6	IO_L20P_6	P44	I/O
6	IO_L21N_6	IO_L21N_6	P43	I/O
6	IO_L21P_6	IO_L21P_6	P42	I/O
6	IO_L22N_6	IO_L22N_6	P40	I/O
6	IO_L22P_6	IO_L22P_6	P39	I/O
6	IO_L23N_6	IO_L23N_6	P37	I/O
6	IO_L23P_6	IO_L23P_6	P36	I/O
6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	P35	VREF
6	IO_L24P_6	IO_L24P_6	P34	I/O
6	N.C. (◆)	IO_L39N_6	P33	I/O
6	N.C. (◆)	IO_L39P_6	P31	I/O
6	IO_L40N_6	IO_L40N_6	P29	I/O
6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	P28	VREF
6	VCCO_6	VCCO_6	P32	VCCO
6	VCCO_6	VCCO_6	P49	VCCO
7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	P3	DCI
7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	P2	DCI
7	N.C. (◆)	IO_L16N_7	P5	I/O
7	N.C. (◆)	IO_L16P_7/VREF_7	P4	VREF
7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	P9	VREF
7	IO_L19P_7	IO_L19P_7	P7	I/O
7	IO_L20N_7	IO_L20N_7	P11	I/O
7	IO_L20P_7	IO_L20P_7	P10	I/O

FT256: 256-lead Fine-pitch Thin Ball Grid Array

The 256-lead fine-pitch thin ball grid array package, FT256, supports three different Spartan-3 devices, including the XC3S200, the XC3S400, and the XC3S1000. The footprints for all three devices are identical, as shown in [Table 96](#) and [Figure 49](#).

All the package pins appear in [Table 96](#) and are sorted by bank number, then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at http://www.xilinx.com/support/documentation/data_sheets/s3_pin.zip.

Pinout Table

Table 96: FT256 Package Pinout

Bank	XC3S200, XC3S400, XC3S1000 Pin Name	FT256 Pin Number	Type
0	IO	A5	I/O
0	IO	A7	I/O
0	IO/VREF_0	A3	VREF
0	IO/VREF_0	D5	VREF
0	IO_L01N_0/VRP_0	B4	DCI
0	IO_L01P_0/VRN_0	A4	DCI
0	IO_L25N_0	C5	I/O
0	IO_L25P_0	B5	I/O
0	IO_L27N_0	E6	I/O
0	IO_L27P_0	D6	I/O
0	IO_L28N_0	C6	I/O
0	IO_L28P_0	B6	I/O
0	IO_L29N_0	E7	I/O
0	IO_L29P_0	D7	I/O
0	IO_L30N_0	C7	I/O
0	IO_L30P_0	B7	I/O
0	IO_L31N_0	D8	I/O
0	IO_L31P_0/VREF_0	C8	VREF
0	IO_L32N_0/GCLK7	B8	GCLK
0	IO_L32P_0/GCLK6	A8	GCLK
0	VCCO_0	E8	VCCO
0	VCCO_0	F7	VCCO
0	VCCO_0	F8	VCCO
1	IO	A9	I/O
1	IO	A12	I/O
1	IO	C10	I/O
1	IO/VREF_1	D12	VREF
1	IO_L01N_1/VRP_1	A14	DCI
1	IO_L01P_1/VRN_1	B14	DCI

Table 100: FG456 Package Pinout (Cont'd)

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
1	IO_L15P_1	IO_L15P_1	E17	I/O
1	IO_L16N_1	IO_L16N_1	B17	I/O
1	IO_L16P_1	IO_L16P_1	C17	I/O
1	N.C. (◆)	IO_L19N_1	C16	I/O
1	N.C. (◆)	IO_L19P_1	D16	I/O
1	N.C. (◆)	IO_L22N_1	A16	I/O
1	N.C. (◆)	IO_L22P_1	B16	I/O
1	IO_L24N_1	IO_L24N_1	D15	I/O
1	IO_L24P_1	IO_L24P_1	E15	I/O
1	IO_L25N_1	IO_L25N_1	B15	I/O
1	IO_L25P_1	IO_L25P_1	A15	I/O
1	IO_L27N_1	IO_L27N_1	D14	I/O
1	IO_L27P_1	IO_L27P_1	E14	I/O
1	IO_L28N_1	IO_L28N_1	A14	I/O
1	IO_L28P_1	IO_L28P_1	B14	I/O
1	IO_L29N_1	IO_L29N_1	C13	I/O
1	IO_L29P_1	IO_L29P_1	D13	I/O
1	IO_L30N_1	IO_L30N_1	A13	I/O
1	IO_L30P_1	IO_L30P_1	B13	I/O
1	IO_L31N_1/VREF_1	IO_L31N_1/VREF_1	D12	VREF
1	IO_L31P_1	IO_L31P_1	E12	I/O
1	IO_L32N_1/GCLK5	IO_L32N_1/GCLK5	B12	GCLK
1	IO_L32P_1/GCLK4	IO_L32P_1/GCLK4	C12	GCLK
1	VCCO_1	VCCO_1	C15	VCCO
1	VCCO_1	VCCO_1	F15	VCCO
1	VCCO_1	VCCO_1	G12	VCCO
1	VCCO_1	VCCO_1	G13	VCCO
1	VCCO_1	VCCO_1	G14	VCCO
2	IO	IO	C22	I/O
2	IO_L01N_2/VRP_2	IO_L01N_2/VRP_2	C20	DCI
2	IO_L01P_2/VRN_2	IO_L01P_2/VRN_2	C21	DCI
2	IO_L16N_2	IO_L16N_2	D20	I/O
2	IO_L16P_2	IO_L16P_2	D19	I/O
2	IO_L17N_2	IO_L17N_2	D21	I/O
2	IO_L17P_2/VREF_2	IO_L17P_2/VREF_2	D22	VREF
2	IO_L19N_2	IO_L19N_2	E18	I/O
2	IO_L19P_2	IO_L19P_2	F18	I/O
2	IO_L20N_2	IO_L20N_2	E19	I/O
2	IO_L20P_2	IO_L20P_2	E20	I/O
2	IO_L21N_2	IO_L21N_2	E21	I/O

Table 100: FG456 Package Pinout (Cont'd)

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
4	IO_L30N_4/D2	IO_L30N_4/D2	U12	DUAL
4	IO_L30P_4/D3	IO_L30P_4/D3	V12	DUAL
4	IO_L31N_4/INIT_B	IO_L31N_4/INIT_B	W12	DUAL
4	IO_L31P_4/DOUT/BUSY	IO_L31P_4/DOUT/BUSY	Y12	DUAL
4	IO_L32N_4/GCLK1	IO_L32N_4/GCLK1	AA12	GCLK
4	IO_L32P_4/GCLK0	IO_L32P_4/GCLK0	AB12	GCLK
4	VCCO_4	VCCO_4	T12	VCCO
4	VCCO_4	VCCO_4	T13	VCCO
4	VCCO_4	VCCO_4	T14	VCCO
4	VCCO_4	VCCO_4	U15	VCCO
4	VCCO_4	VCCO_4	Y15	VCCO
5	IO	IO	U7	I/O
5	N.C. (◆)	IO	U9	I/O
5	IO	IO	U10	I/O
5	IO	IO	U11	I/O
5	IO	IO	V7	I/O
5	IO	IO	V10	I/O
5	IO/VREF_5	IO/VREF_5	AB11	VREF
5	IO/VREF_5	IO/VREF_5	U6	VREF
5	IO_L01N_5/RDWR_B	IO_L01N_5/RDWR_B	Y4	DUAL
5	IO_L01P_5/CS_B	IO_L01P_5/CS_B	AA3	DUAL
5	IO_L06N_5	IO_L06N_5	AB4	I/O
5	IO_L06P_5	IO_L06P_5	AA4	I/O
5	IO_L09N_5	IO_L09N_5	Y5	I/O
5	IO_L09P_5	IO_L09P_5	W5	I/O
5	IO_L10N_5/VRP_5	IO_L10N_5/VRP_5	AB5	DCI
5	IO_L10P_5/VRN_5	IO_L10P_5/VRN_5	AA5	DCI
5	IO_L15N_5	IO_L15N_5	W6	I/O
5	IO_L15P_5	IO_L15P_5	V6	I/O
5	IO_L16N_5	IO_L16N_5	AA6	I/O
5	IO_L16P_5	IO_L16P_5	Y6	I/O
5	N.C. (◆)	IO_L19N_5	Y7	I/O
5	N.C. (◆)	IO_L19P_5/ VREF_5	W7	VREF
5	N.C. (◆)	IO_L22N_5	AB7	I/O
5	N.C. (◆)	IO_L22P_5	AA7	I/O
5	IO_L24N_5	IO_L24N_5	W8	I/O
5	IO_L24P_5	IO_L24P_5	V8	I/O
5	IO_L25N_5	IO_L25N_5	AB8	I/O
5	IO_L25P_5	IO_L25P_5	AA8	I/O

Table 103: FG676 Package Pinout (Cont'd)

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
0	IO_L09N_0	IO_L09N_0	IO_L09N_0	IO_L09N_0	IO_L09N_0	E7	I/O
0	IO_L09P_0	IO_L09P_0	IO_L09P_0	IO_L09P_0	IO_L09P_0	D7	I/O
0	IO_L10N_0	IO_L10N_0	IO_L10N_0	IO_L10N_0	IO_L10N_0	B7	I/O
0	IO_L10P_0	IO_L10P_0	IO_L10P_0	IO_L10P_0	IO_L10P_0	A7	I/O
0	N.C. (◆)	IO_L11N_0	IO_L11N_0	IO_L11N_0	IO_L11N_0	G8	I/O
0	N.C. (◆)	IO_L11P_0	IO_L11P_0	IO_L11P_0	IO_L11P_0	F8	I/O
0	N.C. (◆)	IO_L12N_0	IO_L12N_0	IO_L12N_0	IO ⁽³⁾	E8	I/O
0	N.C. (◆)	IO_L12P_0	IO_L12P_0	IO_L12P_0	IO ⁽³⁾	D8	I/O
0	IO_L15N_0	IO_L15N_0	IO_L15N_0	IO_L15N_0	IO_L13P_0 ⁽³⁾	B8	I/O
0	IO_L15P_0	IO_L15P_0	IO_L15P_0	IO_L15P_0	IO ⁽³⁾	A8	I/O
0	IO_L16N_0	IO_L16N_0	IO_L16N_0	IO_L16N_0	IO_L16N_0	G9	I/O
0	IO_L16P_0	IO_L16P_0	IO_L16P_0	IO_L16P_0	IO_L16P_0	F9	I/O
0	N.C. (◆)	IO_L17N_0	IO_L17N_0	IO_L17N_0	IO_L17N_0	E9	I/O
0	N.C. (◆)	IO_L17P_0	IO_L17P_0	IO_L17P_0	IO_L17P_0	D9	I/O
0	N.C. (◆)	IO_L18N_0	IO_L18N_0	IO_L18N_0	IO_L18N_0	C9	I/O
0	N.C. (◆)	IO_L18P_0	IO_L18P_0	IO_L18P_0	IO_L18P_0	B9	I/O
0	IO_L19N_0	IO_L19N_0	IO_L19N_0	IO_L19N_0	IO_L19N_0	F10	I/O
0	IO_L19P_0	IO_L19P_0	IO_L19P_0	IO_L19P_0	IO_L19P_0	E10	I/O
0	IO_L22N_0	IO_L22N_0	IO_L22N_0	IO_L22N_0	IO_L22N_0	D10	I/O
0	IO_L22P_0	IO_L22P_0	IO_L22P_0	IO_L22P_0	IO_L22P_0	C10	I/O
0	N.C. (◆)	IO_L23N_0	IO_L23N_0	IO_L23N_0	IO_L23N_0	B10	I/O
0	N.C. (◆)	IO_L23P_0	IO_L23P_0	IO_L23P_0	IO_L23P_0	A10	I/O
0	IO_L24N_0	IO_L24N_0	IO_L24N_0	IO_L24N_0	IO_L24N_0	G11	I/O
0	IO_L24P_0	IO_L24P_0	IO_L24P_0	IO_L24P_0	IO_L24P_0	F11	I/O
0	IO_L25N_0	IO_L25N_0	IO_L25N_0	IO_L25N_0	IO_L25N_0	E11	I/O
0	IO_L25P_0	IO_L25P_0	IO_L25P_0	IO_L25P_0	IO_L25P_0	D11	I/O
0	N.C. (◆)	IO_L26N_0	IO_L26N_0	IO_L26N_0	IO_L26N_0	B11	I/O
0	N.C. (◆)	IO_L26P_0/VREF_0	IO_L26P_0/VREF_0	IO_L26P_0/VREF_0	IO_L26P_0/VREF_0	A11	VREF
0	IO_L27N_0	IO_L27N_0	IO_L27N_0	IO_L27N_0	IO_L27N_0	G12	I/O
0	IO_L27P_0	IO_L27P_0	IO_L27P_0	IO_L27P_0	IO_L27P_0	H13	I/O
0	IO_L28N_0	IO_L28N_0	IO_L28N_0	IO_L28N_0	IO_L28N_0	F12	I/O
0	IO_L28P_0	IO_L28P_0	IO_L28P_0	IO_L28P_0	IO_L28P_0	E12	I/O
0	IO_L29N_0	IO_L29N_0	IO_L29N_0	IO_L29N_0	IO_L29N_0	B12	I/O
0	IO_L29P_0	IO_L29P_0	IO_L29P_0	IO_L29P_0	IO_L29P_0	A12	I/O
0	IO_L30N_0	IO_L30N_0	IO_L30N_0	IO_L30N_0	IO_L30N_0	G13	I/O
0	IO_L30P_0	IO_L30P_0	IO_L30P_0	IO_L30P_0	IO_L30P_0	F13	I/O
0	IO_L31N_0	IO_L31N_0	IO_L31N_0	IO_L31N_0	IO_L31N_0	D13	I/O
0	IO_L31P_0/VREF_0	IO_L31P_0/VREF_0	IO_L31P_0/VREF_0	IO_L31P_0/VREF_0	IO_L31P_0/VREF_0	C13	VREF
0	IO_L32N_0/GCLK7	IO_L32N_0/GCLK7	IO_L32N_0/GCLK7	IO_L32N_0/GCLK7	IO_L32N_0/GCLK7	B13	GCLK
0	IO_L32P_0/GCLK6	IO_L32P_0/GCLK6	IO_L32P_0/GCLK6	IO_L32P_0/GCLK6	IO_L32P_0/GCLK6	A13	GCLK
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	C7	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	C11	VCCO

Table 103: FG676 Package Pinout (Cont'd)

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	H9	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	H10	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	J11	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	J12	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	J13	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	K13	VCCO
1	IO	IO	IO	IO	IO	A14	I/O
1	IO	IO	IO	IO	IO	A22	I/O
1	IO	IO	IO	IO	IO	A23	I/O
1	IO	IO	IO	IO	IO	D16	I/O
1	IO	IO	IO	IO	IO_L17P_1 ⁽³⁾	E18	I/O
1	IO	IO	IO	IO	IO	F14	I/O
1	IO	IO	IO	IO	IO	F20	I/O
1	IO	IO	IO	IO	IO	G19	I/O
1	IO/VREF_1	IO/VREF_1	IO/VREF_1	IO/VREF_1	IO/VREF_1	C15	VREF
1	IO/VREF_1	IO/VREF_1	IO/VREF_1	IO/VREF_1	IO/VREF_1	C17	VREF
1	N.C. (◆)	IO/VREF_1	IO/VREF_1	IO/VREF_1	IO_L17N_1/VREF_1 ⁽³⁾	D18	VREF
1	IO_L01N_1/VRP_1	IO_L01N_1/VRP_1	IO_L01N_1/VRP_1	IO_L01N_1/VRP_1	IO_L01N_1/VRP_1	D22	DCI
1	IO_L01P_1/VRN_1	IO_L01P_1/VRN_1	IO_L01P_1/VRN_1	IO_L01P_1/VRN_1	IO_L01P_1/VRN_1	E22	DCI
1	IO_L04N_1	IO_L04N_1	IO_L04N_1	IO_L04N_1	IO_L04N_1	B23	I/O
1	IO_L04P_1	IO_L04P_1	IO_L04P_1	IO_L04P_1	IO_L04P_1	C23	I/O
1	IO_L05N_1	IO_L05N_1	IO_L05N_1	IO_L05N_1	IO_L05N_1	E21	I/O
1	IO_L05P_1	IO_L05P_1	IO_L05P_1	IO_L05P_1	IO_L05P_1	F21	I/O
1	IO_L06N_1/VREF_1	IO_L06N_1/VREF_1	IO_L06N_1/VREF_1	IO_L06N_1/VREF_1	IO_L06N_1/VREF_1	B22	VREF
1	IO_L06P_1	IO_L06P_1	IO_L06P_1	IO_L06P_1	IO_L06P_1	C22	I/O
1	IO_L07N_1	IO_L07N_1	IO_L07N_1	IO_L07N_1	IO_L07N_1	C21	I/O
1	IO_L07P_1	IO_L07P_1	IO_L07P_1	IO_L07P_1	IO_L07P_1	D21	I/O
1	IO_L08N_1	IO_L08N_1	IO_L08N_1	IO_L08N_1	IO_L08N_1	A21	I/O
1	IO_L08P_1	IO_L08P_1	IO_L08P_1	IO_L08P_1	IO_L08P_1	B21	I/O
1	IO_L09N_1	IO_L09N_1	IO_L09N_1	IO_L09N_1	IO_L09N_1	D20	I/O
1	IO_L09P_1	IO_L09P_1	IO_L09P_1	IO_L09P_1	IO_L09P_1	E20	I/O
1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	A20	VREF
1	IO_L10P_1	IO_L10P_1	IO_L10P_1	IO_L10P_1	IO_L10P_1	B20	I/O
1	N.C. (◆)	IO_L11N_1	IO_L11N_1	IO_L11N_1	IO_L11N_1	E19	I/O
1	N.C. (◆)	IO_L11P_1	IO_L11P_1	IO_L11P_1	IO_L11P_1	F19	I/O
1	N.C. (◆)	IO_L12N_1	IO_L12N_1	IO_L12N_1	IO_L12N_1	C19	I/O
1	N.C. (◆)	IO_L12P_1	IO_L12P_1	IO_L12P_1	IO_L12P_1	D19	I/O
1	IO_L15N_1	IO_L15N_1	IO_L15N_1	IO_L15N_1	IO_L15N_1	A19	I/O
1	IO_L15P_1	IO_L15P_1	IO_L15P_1	IO_L15P_1	IO_L15P_1	B19	I/O
1	IO_L16N_1	IO_L16N_1	IO_L16N_1	IO_L16N_1	IO_L16N_1	F18	I/O
1	IO_L16P_1	IO_L16P_1	IO_L16P_1	IO_L16P_1	IO_L16P_1	G18	I/O
1	N.C. (◆)	IO_L18N_1	IO_L18N_1	IO_L18N_1	IO ⁽³⁾	B18	I/O

Table 103: FG676 Package Pinout (Cont'd)

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
3	IO_L19N_3	IO_L19N_3	IO_L19N_3	IO_L19N_3	IO_L19N_3	W26	I/O
3	IO_L19P_3	IO_L19P_3	IO_L19P_3	IO_L19P_3	IO_L19P_3	W25	I/O
3	IO_L20N_3	IO_L20N_3	IO_L20N_3	IO_L20N_3	IO_L20N_3	U20	I/O
3	IO_L20P_3	IO_L20P_3	IO_L20P_3	IO_L20P_3	IO_L20P_3	V20	I/O
3	IO_L21N_3	IO_L21N_3	IO_L21N_3	IO_L21N_3	IO_L21N_3	V23	I/O
3	IO_L21P_3	IO_L21P_3	IO_L21P_3	IO_L21P_3	IO_L21P_3	V22	I/O
3	IO_L22N_3	IO_L22N_3	IO_L22N_3	IO_L22N_3	IO_L22N_3	V25	I/O
3	IO_L22P_3	IO_L22P_3	IO_L22P_3	IO_L22P_3	IO_L22P_3	V24	I/O
3	IO_L23N_3	IO_L23N_3	IO_L23N_3	IO_L23N_3	IO_L23N_3	U22	I/O
3	IO_L23P_3/VREF_3	IO_L23P_3/VREF_3	IO_L23P_3/VREF_3	IO_L23P_3/VREF_3	IO_L23P_3/VREF_3	U21	VREF
3	IO_L24N_3	IO_L24N_3	IO_L24N_3	IO_L24N_3	IO_L24N_3	U24	I/O
3	IO_L24P_3	IO_L24P_3	IO_L24P_3	IO_L24P_3	IO_L24P_3	U23	I/O
3	IO_L26N_3	IO_L26N_3	IO_L26N_3	IO_L26N_3	IO_L26N_3	U26	I/O
3	IO_L26P_3	IO_L26P_3	IO_L26P_3	IO_L26P_3	IO_L26P_3	U25	I/O
3	IO_L27N_3	IO_L27N_3	IO_L27N_3	IO_L27N_3	IO_L27N_3	T20	I/O
3	IO_L27P_3	IO_L27P_3	IO_L27P_3	IO_L27P_3	IO_L27P_3	T19	I/O
3	IO_L28N_3	IO_L28N_3	IO_L28N_3	IO_L28N_3	IO_L28N_3	T22	I/O
3	IO_L28P_3	IO_L28P_3	IO_L28P_3	IO_L28P_3	IO_L28P_3	T21	I/O
3	IO_L29N_3	IO_L29N_3	IO_L29N_3	IO_L29N_3	IO_L29N_3	T26	I/O
3	IO_L29P_3	IO_L29P_3	IO_L29P_3	IO_L29P_3	IO_L29P_3	T25	I/O
3	IO_L31N_3	IO_L31N_3	IO_L31N_3	IO_L31N_3	IO_L31N_3	R20	I/O
3	IO_L31P_3	IO_L31P_3	IO_L31P_3	IO_L31P_3	IO_L31P_3	R19	I/O
3	IO_L32N_3	IO_L32N_3	IO_L32N_3	IO_L32N_3	IO_L32N_3	R22	I/O
3	IO_L32P_3	IO_L32P_3	IO_L32P_3	IO_L32P_3	IO_L32P_3	R21	I/O
3	IO_L33N_3	IO_L33N_3	IO_L33N_3	IO_L33N_3	IO_L33N_3	R24	I/O
3	IO_L33P_3	IO_L33P_3	IO_L33P_3	IO_L33P_3	IO_L33P_3	T23	I/O
3	IO_L34N_3	IO_L34N_3	IO_L34N_3	IO_L34N_3	IO_L34N_3	R26	I/O
3	IO_L34P_3/VREF_3	IO_L34P_3/VREF_3	IO_L34P_3/VREF_3	IO_L34P_3/VREF_3	IO_L34P_3/VREF_3	R25	VREF
3	IO_L35N_3	IO_L35N_3	IO_L35N_3	IO_L35N_3	IO_L35N_3	P20	I/O
3	IO_L35P_3	IO_L35P_3	IO_L35P_3	IO_L35P_3	IO_L35P_3	P19	I/O
3	IO_L38N_3	IO_L38N_3	IO_L38N_3	IO_L38N_3	IO_L38N_3	P22	I/O
3	IO_L38P_3	IO_L38P_3	IO_L38P_3	IO_L38P_3	IO_L38P_3	P21	I/O
3	IO_L39N_3	IO_L39N_3	IO_L39N_3	IO_L39N_3	IO_L39N_3	P24	I/O
3	IO_L39P_3	IO_L39P_3	IO_L39P_3	IO_L39P_3	IO_L39P_3	P23	I/O
3	IO_L40N_3/VREF_3	IO_L40N_3/VREF_3	IO_L40N_3/VREF_3	IO_L40N_3/VREF_3	IO_L40N_3/VREF_3	P26	VREF
3	IO_L40P_3	IO_L40P_3	IO_L40P_3	IO_L40P_3	IO_L40P_3	P25	I/O
3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	P17	VCCO
3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	P18	VCCO
3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	R18	VCCO
3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	T18	VCCO
3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	T24	VCCO
3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	U19	VCCO
3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	VCCO_3	V19	VCCO

Table 107: FG900 Package Pinout (Cont'd)

Bank	XC3S2000 Pin Name	XC3S4000, XC3S5000 Pin Name	FG900 Pin Number	Type
2	IO_L28N_2	IO_L28N_2	M26	I/O
2	IO_L28P_2	IO_L28P_2	N25	I/O
2	IO_L29N_2	IO_L29N_2	N26	I/O
2	IO_L29P_2	IO_L29P_2	N27	I/O
2	IO_L31N_2	IO_L31N_2	N29	I/O
2	IO_L31P_2	IO_L31P_2	N30	I/O
2	IO_L32N_2	IO_L32N_2	P21	I/O
2	IO_L32P_2	IO_L32P_2	P22	I/O
2	IO_L33N_2	IO_L33N_2	P24	I/O
2	IO_L33P_2	IO_L33P_2	P25	I/O
2	IO_L34N_2/VREF_2	IO_L34N_2/VREF_2	P28	VREF
2	IO_L34P_2	IO_L34P_2	P29	I/O
2	IO_L35N_2	IO_L35N_2	R21	I/O
2	IO_L35P_2	IO_L35P_2	R22	I/O
2	IO_L37N_2	IO_L37N_2	R23	I/O
2	IO_L37P_2	IO_L37P_2	R24	I/O
2	IO_L38N_2	IO_L38N_2	R25	I/O
2	IO_L38P_2	IO_L38P_2	R26	I/O
2	IO_L39N_2	IO_L39N_2	R27	I/O
2	IO_L39P_2	IO_L39P_2	R28	I/O
2	IO_L40N_2	IO_L40N_2	R29	I/O
2	IO_L40P_2/VREF_2	IO_L40P_2/VREF_2	R30	VREF
2	N.C. (◆)	IO_L41N_2	E27	I/O
2	N.C. (◆)	IO_L41P_2	F26	I/O
2	N.C. (◆)	IO_L45N_2	K28	I/O
2	N.C. (◆)	IO_L45P_2	K29	I/O
2	N.C. (◆)	IO_L46N_2	K21	I/O
2	N.C. (◆)	IO_L46P_2	L21	I/O
2	N.C. (◆)	IO_L47N_2	L23	I/O
2	N.C. (◆)	IO_L47P_2	L24	I/O
2	N.C. (◆)	IO_L50N_2	M29	I/O
2	N.C. (◆)	IO_L50P_2	M30	I/O
2	VCCO_2	VCCO_2	M20	VCCO
2	VCCO_2	VCCO_2	N20	VCCO
2	VCCO_2	VCCO_2	P20	VCCO
2	VCCO_2	VCCO_2	L22	VCCO
2	VCCO_2	VCCO_2	J24	VCCO
2	VCCO_2	VCCO_2	N24	VCCO
2	VCCO_2	VCCO_2	G26	VCCO
2	VCCO_2	VCCO_2	E28	VCCO

Table 107: FG900 Package Pinout (Cont'd)

Bank	XC3S2000 Pin Name	XC3S4000, XC3S5000 Pin Name	FG900 Pin Number	Type
3	N.C. (◆)	IO_L50P_3	V26	I/O
3	VCCO_3	VCCO_3	U20	VCCO
3	VCCO_3	VCCO_3	V20	VCCO
3	VCCO_3	VCCO_3	W20	VCCO
3	VCCO_3	VCCO_3	Y22	VCCO
3	VCCO_3	VCCO_3	V24	VCCO
3	VCCO_3	VCCO_3	AB24	VCCO
3	VCCO_3	VCCO_3	AD26	VCCO
3	VCCO_3	VCCO_3	V28	VCCO
3	VCCO_3	VCCO_3	AB28	VCCO
3	VCCO_3	VCCO_3	AF28	VCCO
4	IO	IO	AA16	I/O
4	IO	IO	AG18	I/O
4	IO	IO	AA18	I/O
4	IO	IO	AE22	I/O
4	IO	IO	AD23	I/O
4	IO	IO	AH27	I/O
4	IO/VREF_4	IO/VREF_4	AF16	VREF
4	IO/VREF_4	IO/VREF_4	AK28	VREF
4	IO_L01N_4/VRP_4	IO_L01N_4/VRP_4	AJ27	DCI
4	IO_L01P_4/VRN_4	IO_L01P_4/VRN_4	AK27	DCI
4	IO_L02N_4	IO_L02N_4	AJ26	I/O
4	IO_L02P_4	IO_L02P_4	AK26	I/O
4	IO_L03N_4	IO_L03N_4	AG26	I/O
4	IO_L03P_4	IO_L03P_4	AF25	I/O
4	IO_L04N_4	IO_L04N_4	AD24	I/O
4	IO_L04P_4	IO_L04P_4	AC23	I/O
4	IO_L05N_4	IO_L05N_4	AE23	I/O
4	IO_L05P_4	IO_L05P_4	AF23	I/O
4	IO_L06N_4/VREF_4	IO_L06N_4/VREF_4	AG23	VREF
4	IO_L06P_4	IO_L06P_4	AH23	I/O
4	IO_L07N_4	IO_L07N_4	AJ23	I/O
4	IO_L07P_4	IO_L07P_4	AK23	I/O
4	IO_L08N_4	IO_L08N_4	AB22	I/O
4	IO_L08P_4	IO_L08P_4	AC22	I/O
4	IO_L09N_4	IO_L09N_4	AF22	I/O
4	IO_L09P_4	IO_L09P_4	AG22	I/O
4	IO_L10N_4	IO_L10N_4	AJ22	I/O
4	IO_L10P_4	IO_L10P_4	AK22	I/O
4	IO_L11N_4	IO_L11N_4	AD21	I/O

Table 107: FG900 Package Pinout (Cont'd)

Bank	XC3S2000 Pin Name	XC3S4000, XC3S5000 Pin Name	FG900 Pin Number	Type
4	IO_L31P_4/DOUT/BUSY	IO_L31P_4/DOUT/BUSY	AH16	DUAL
4	IO_L32N_4/GCLK1	IO_L32N_4/GCLK1	AJ16	GCLK
4	IO_L32P_4/GCLK0	IO_L32P_4/GCLK0	AK16	GCLK
4	N.C. (◆)	IO_L33N_4	AH25	I/O
4	N.C. (◆)	IO_L33P_4	AJ25	I/O
4	N.C. (◆)	IO_L34N_4	AE25	I/O
4	N.C. (◆)	IO_L34P_4	AE24	I/O
4	N.C. (◆)	IO_L35N_4	AG24	I/O
4	N.C. (◆)	IO_L35P_4	AH24	I/O
4	N.C. (◆)	IO_L38N_4	AJ24	I/O
4	N.C. (◆)	IO_L38P_4	AK24	I/O
4	VCCO_4	VCCO_4	Y17	VCCO
4	VCCO_4	VCCO_4	Y18	VCCO
4	VCCO_4	VCCO_4	AD18	VCCO
4	VCCO_4	VCCO_4	AH18	VCCO
4	VCCO_4	VCCO_4	Y19	VCCO
4	VCCO_4	VCCO_4	AB20	VCCO
4	VCCO_4	VCCO_4	AD22	VCCO
4	VCCO_4	VCCO_4	AH22	VCCO
4	VCCO_4	VCCO_4	AF24	VCCO
4	VCCO_4	VCCO_4	AH26	VCCO
5	IO	IO	AE6	I/O
5	IO	IO	AB10	I/O
5	IO	IO	AA11	I/O
5	IO	IO	AA15	I/O
5	IO	IO	AE15	I/O
5	IO/VREF_5	IO/VREF_5	AH4	VREF
5	IO/VREF_5	IO/VREF_5	AK15	VREF
5	IO_L01N_5/RDWR_B	IO_L01N_5/RDWR_B	AK4	DUAL
5	IO_L01P_5/CS_B	IO_L01P_5/CS_B	AJ4	DUAL
5	IO_L02N_5	IO_L02N_5	AK5	I/O
5	IO_L02P_5	IO_L02P_5	AJ5	I/O
5	IO_L03N_5	IO_L03N_5	AF6	I/O
5	IO_L03P_5	IO_L03P_5	AG5	I/O
5	IO_L04N_5	IO_L04N_5	AJ6	I/O
5	IO_L04P_5	IO_L04P_5	AH6	I/O
5	IO_L05N_5	IO_L05N_5	AE7	I/O
5	IO_L05P_5	IO_L05P_5	AD7	I/O
5	IO_L06N_5	IO_L06N_5	AH7	I/O
5	IO_L06P_5	IO_L06P_5	AG7	I/O

Table 110: FG1156 Package Pinout (Cont'd)

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
1	VCCO_1	VCCO_1	M22	VCCO
2	IO	IO	G33	I/O
2	IO	IO	G34	I/O
2	IO	IO	U25	I/O
2	IO	IO	U26	I/O
2	IO_L01N_2/VRP_2	IO_L01N_2/VRP_2	C33	DCI
2	IO_L01P_2/VRN_2	IO_L01P_2/VRN_2	C34	DCI
2	IO_L02N_2	IO_L02N_2	D33	I/O
2	IO_L02P_2	IO_L02P_2	D34	I/O
2	IO_L03N_2/VREF_2	IO_L03N_2/VREF_2	E32	VREF
2	IO_L03P_2	IO_L03P_2	E33	I/O
2	IO_L04N_2	IO_L04N_2	F31	I/O
2	IO_L04P_2	IO_L04P_2	F32	I/O
2	IO_L05N_2	IO_L05N_2	G29	I/O
2	IO_L05P_2	IO_L05P_2	G30	I/O
2	IO_L06N_2	IO_L06N_2	H29	I/O
2	IO_L06P_2	IO_L06P_2	H30	I/O
2	IO_L07N_2	IO_L07N_2	H33	I/O
2	IO_L07P_2	IO_L07P_2	H34	I/O
2	IO_L08N_2	IO_L08N_2	J28	I/O
2	IO_L08P_2	IO_L08P_2	J29	I/O
2	IO_L09N_2/VREF_2	IO_L09N_2/VREF_2	H31	VREF
2	IO_L09P_2	IO_L09P_2	J31	I/O
2	IO_L10N_2	IO_L10N_2	J32	I/O
2	IO_L10P_2	IO_L10P_2	J33	I/O
2	IO_L11N_2	IO_L11N_2	J27	I/O
2	IO_L11P_2	IO_L11P_2	K26	I/O
2	IO_L12N_2	IO_L12N_2	K27	I/O
2	IO_L12P_2	IO_L12P_2	K28	I/O
2	IO_L13N_2	IO_L13N_2	K29	I/O
2	IO_L13P_2/VREF_2	IO_L13P_2/VREF_2	K30	VREF
2	IO_L14N_2	IO_L14N_2	K31	I/O
2	IO_L14P_2	IO_L14P_2	K32	I/O
2	IO_L15N_2	IO_L15N_2	K33	I/O
2	IO_L15P_2	IO_L15P_2	K34	I/O
2	IO_L16N_2	IO_L16N_2	L25	I/O
2	IO_L16P_2	IO_L16P_2	L26	I/O
2	N.C. (◆)	IO_L17N_2	L28	I/O
2	N.C. (◆)	IO_L17P_2/ VREF_2	L29	VREF